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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HYUN SOO JANG	07/11/2016
JEONG HO LEE	07/11/2016
WOO CHAN KIM	07/12/2016
SUNG HOON JUN	07/11/2016
JONG WON SHON	07/11/2016

RECEIVING PARTY DATA

Name:	ASM IP HOLDING B.V.
Street Address:	VERSTERKERSTRAAT 8
City:	ALMERE
State/Country:	NETHERLANDS
Postal Code:	1322 AP

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15232603

CORRESPONDENCE DATA

Fax Number: (949)760-9502

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 9497600404

Email: efiling@knobbe.com

Correspondent Name: KNOBBE, MARTENS, OLSON & BEAR LLP

Address Line 1: 2040 MAIN STREET

Address Line 2: 14TH FLOOR

Address Line 4: IRVINE, CALIFORNIA 92614

Total Attachments: 0	·
DATE SIGNED:	09/28/2018
SIGNATURE:	/Adeel Syed Akhtar/
NAME OF SUBMITTER:	ADEEL S. AKHTAR
ATTORNEY DOCKET NUMBER:	ASMYPL.011AUS

Total Attachments: 2

PATENT REEL: 047008 FRAME: 0778

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PATENT REEL: 047008 FRAME: 0779

COMBINED DECLARATION & ASSIGNMENT (37 CFR 1.63(e))

Application Data Sheet filed previously or concurrently

Docket No.: ASMYPL.011AUS

Page 1 of 2

Title: THIN FILM DEPOSITION APPARATUS

Inventor(s): Hyun Soo Jang, Jeong Ho Lee, Woo Chan Kim, Sung Hoon Jun, Jong Won Shon

Declaration

This Declaration is directed to the invention identified above that:

Is attached, where "attached" means filed concurrently with.

As a named inventor, I declare that:

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

I hereby state that I have reviewed and understand the contents of the above identified specification and acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56.

Assignment from Inventor(s)

WHEREAS, above-identified inventor(s) (individual(s) hereinafter "ASSIGNOR") invented certain new and useful improvements, technology, inventions, developments, ideas or discoveries, and hereby assign or are under an obligation to assign to the below identified Assignee the above-titled application (collectively hereinafter referred to as the "Work") for which an application for Letters Patent in the United States (identified above) has been prepared for filing with the United States Patent and Trademark Office (hereinafter the "Application").

AND WHEREAS, ASM IP Holding B.V., with its principal place of business at Versterkerstraat 8, 1322 AP Almere, The Netherlands (hereinafter the "ASSIGNEE"), desires to acquire the entire right, title, and interest in and to the Application and the Work.

NOW, THEREFORE, for good and valuable consideration of which receipt is hereby acknowledged, ASSIGNOR hereby acknowledges that ASSIGNOR has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest in the Application, including all patent properties filed or issued upon the Application; where "Patent Properties" include, but are not limited to:

all provisional applications to which the Application claims priority;

all nonprovisional applications claiming priority to aforementioned provisional(s) and/or the present Application, including, all divisions, continuations, continuations-in-part, and reissues, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof;

ASSIGNOR hereby acknowledges the ASSIGNEE as the Applicant for all aforementioned patent properties, and authorizes and requests the Commissioner of Patents of the United States to issue all related Letters Patent to the ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND ASSIGNOR DOES HEREBY sell, assign, transfer, and convey to ASSIGNEE, its successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the rights assigned hereby that may have accrued prior to the date of assignment to ASSIGNEE, or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of said Letters Patent before or after issuance.

PATENT REEL: 047008 FRAME: 0780

COMBINED	DECLARATION	& ASSIGNMENT	(37 CFR 1.63(e))

Application Data Sheet filed previously or concurrently

Docket No.: ASMYPL.011AUS		Page 2 of 2	
Title: THIN FILM DEPOSITION APPARATUS			
Inventor(s): Hyun Soo Jang, Jeong Ho Lee, Woo Chan Kim, Sung Hoon Jun, Jong Won Shon AND ASSIGNOR DOES HEREBY covenant and agree that ASSIGNOR will communicate to said ASSIGNEE, its successors, legal representatives and assigns, any facts known to ASSIGNOR respecting the Work, and testify in any legal proceeding, assist in the preparation of any other Patent Property relating to the Application, and the Work or any improvements made thereto, sign/execute all lawful papers, execute and make all rightful oaths and/or declarations in connection with the Application and the Work including any improvements made thereto, any patent applications filed therefrom, and any continuing application filed from any of the aforementioned applications, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for the Patent Properties.			
Legal Name of inventor 1: Hyun Soo Jang	***************************************		
Signature:	Date:	7-11-2016	
Legal Name of Inventor 2: Jeong Ho Lee Signature:	Date:	7-11-20/6	
Legal Name of inventor 3: Woo Chan Kim Signature:	f>_i_	D. 12 - 20//	
Legal Name of inventor 4: Sung Hoon Jun	Date.	7-12-20/6	
Signature:	Date:	7-11-2016	

Legal Name of inventor 5: Jong Won Shon

Signature: \(\int \int \int \sqrt{\sq}}}}\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sq}}}}}}}\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sq}}}}}}}}\signation}\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sq}}}}}}}\signation}\sqrt{\sqrt{\sqrt{\sq}\signation}}\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sqrt{\sq}}}}}\sqrt{\sq}\signation}\squat{\sqrt{\sint{\sint{\sint{\sint{\sinitita}}}}}}}\signation}\signi

Date: 7-//-22/6

PATENT REEL: 047008 FRAME: 0781

RECORDED: 09/28/2018